

Reply under 37 C.F.R. 1.116
Expedited Procedure
Technology Center 2822

Confirmation No. 3088

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	HESEN, <i>et al.</i>	Examiner:	Chhaya, S.
Serial No.:	10/560,447	Group Art Unit:	2822
Filed:	December 12, 2005	Docket No.:	NL030692US1
Title:	LEAD FRAME, METHOD OF MANUFACTURING A SEMICONDUCTOR DEVICE		

FINAL OFFICE ACTION AMENDMENT AND RESPONSE

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Customer No. 65913

Dear Sir:

In response to the Final Office Action dated February 12, 2008, please reconsider the application in view of the following amendments and remarks.

A complete listing of the claims, to include any amendments presented therein, begins on page 2 of this paper.

Remarks/Arguments follow on page 7.

Authorization is provided to charge/credit Deposit Account 50-0996 (NXPS.316PA) any requisite fees/overages to enter this paper.